1. Attempt any five of the following :—
   (a) Define ecology and ecosystem.
   (b) What do you mean by Bio-energy? Explain with example.
   (c) Explain the term “Biodiversity” with the help of an example.
   (d) How pesticides contribute to soil pollution? Explain.
   (e) Explain the term “sustainable development”.
   (f) Differentiate between exponential and geometrical population growth.
   (g) What are –3R? Explain.

2. (a) Describe the role of information technology in environmental studies.
     (b) Discuss rain water harvesting. What are advantages from this technique?

3. (a) Write short notes on any two of the following :
      (i) Thermal Pollution
      (ii) Solid Waste Management
      (iii) Phopal Gas Tragedy.
     (b) Write an essay on “Hot-spot of biodiversity”.

4. (a) Write short notes on any two of the following :
      (i) Ecological Succession
      (ii) Estuaries
      (iii) Food Web.
     (b) “It is said that next World War will be on water.” Comment upon the statement giving facts.

5. (a) Explain soil erosion. How it happened? Give its types.
     (b) What is conservation of biodiversity? Describe in-situ and ex-situ conservation of biodiversity.

6. (a) Write an essay on disaster management.
     (b) Write short notes on any two of the following :
         (i) Green House Effect
         (ii) Ozone Layer Depletion
         (iii) Water Shed Management.

7. (a) Discuss salient features of –
         (ii) Forest (Conservation) Act, 1980.
     (b) Explain various causes of water pollution.

*********
N.B. (1) Question No. 1 is compulsory.
(2) Attempt any four questions from remaining six questions.
(3) Assume data if necessary.

1. (a) (i) Interface 16 KB RAM memory chip to 8085 using Absolute decoding technique. 4
(ii) Modify the address decoding circuit in the above design to incorporate partial decoding and thus explain the difference between Absolute decoding technique and partial decoding technique. 4
(b) (i) Draw and explain the formats of Interrupt Enable SFR and Interrupt Priority SFR of 8051. 4
(ii) Write a program to enable all the interrupts of 8051 and set the priority of all interrupts of 8051 to low level. 4
(c) Explain any two addressing modes of ARM processor with suitable examples. 4

2. (a) Analyze the given subroutine and answer the following:
MVIC O5H
up MOV A, C
DCRC
JNZ up
RET
(i) Calculate the time delay produced by the given subroutine. Assume the crystal frequency of 8085 to 6MHz. 5
(ii) Calculate the maximum time delay that can be produced by the given subroutine. Assume the crystal frequency of 8085 to 6 MHz. 5
(b) Draw and explain the Internal Memory Organization of 8051. 10

3. (a) Assume an oscillator running at 12 MHz controls 8051 micro controller. Write a program to generate 2 KHz square wave on P1.0 using Timer 0 in mode 1. 10
(b) Interface 8155 to 8085 in memory mapped I/O mode using Absolute decoding technique. 10

4. (a) Analyze the given program and answer the following:
MVIA, 4BH
SIM
EI
HLT
(i) What is the status (Masked/Unmasked) of 5 Hardware interrupts of 8085 after executing the program and why? 5
(ii) What is the status of SOD pin after executing the program and why? 5
(b) (i) Draw and explain the internal structure of port 0 of 8051. 6
(ii) Explain the features of port 3 of 8051. 4
5. (a) Interface single 8259 to 8085 in I/O mapped I/O mode using Absolute decoding technique.
(b) (i) Compare the Power down mode and Idle mode of 8051.
(ii) Explain any four bit level instructions of 8051.

6. (a) (i) Write a program to continuously turn ON and OFF a LED Connected to PCs of Port C of 8255 using BSR mode (8255 is connected to 8085).
(ii) Specify the number of Machine cycles, T-states, addressing mode and number of bytes for the instruction POP PSW and INR M of 8085.
(b) Explain the key features of ARM Processor Architecture.

7. (a) Draw and explain Timing Diagram for the instruction LDAX B of 8085.
(b) Specify and explain any five instructions of ARM processor.
1. (a) (i) Interface 16 KB RAM memory chip to 8085 using Absolute decoding technique. 4 4
   (ii) Modify the address decoding circuit in the above design to incorporate partial 4 4
        decoding and thus explain the difference between Absolute decoding
        technique and partial decoding technique.
(b) (i) Draw and explain the formats of Interrupt Enable SFR and Interrupt Priority 4 4
      SFR of 8051.
   (ii) Write a program to enable all the interrupts of 8051 and set the priority of 4 4
        all interrupts of 8051 to low level.
(c) Explain any two addressing modes of ARM processor with suitable examples. 4

2. (a) Analyze the given subroutine and answer the following:—
      MVIC, O5H
      up MOV A, C
      DCRC
      JNZ up
      RET
   (i) Calculate the time delay produced by the given subroutine. Assume the 5 5
       crystal frequency of 8085 to 6MHz.
   (ii) Calculate the maximum time delay that can be produced by the given 5 5
        subroutine. Assume the crystal frequency of 8085 to 6 MHz.
(b) Draw and explain the Internal Memory Organization of 8051. 10

3. (a) Assume an oscillator running at 12 MHz controls 8051 micro controller. Write 10
      a program to generate 2 KHz square wave on P1.0 using Timer 0 in mode 1.
(b) Interface 8155 to 8085 in memory mapped I/O mode using Absolute decoding 10
    technique.

4. (a) Analyze the given program and answer the following:—
      MVIA, 4 BH
      SIM
      EI
      HLT
   (i) What is the status (Masked/Unmasked) of 5 Hardware interrupts of 8085 5 5
       after executing the program and why?
   (ii) What is the status of SOD pin after executing the program and why? 5
(b) (i) Draw and explain the internal structure of port 0 of 8051. 6
   (ii) Explain the features of port 3 of 8051. 4
5. (a) Interface single 8259 to 8085 in I/O mapped I/O mode using Absolute decoding technique.
   (b) (i) Compare the Power down mode and Idle mode of 8051.
       (ii) Explain any four, bit level instructions of 8051.

6. (a) (i) Write a program to continuously turn ON and OFF a LED Connected to PC5 of Port C of 8255 using BSR mode (8255 is connected to 8085).
       (ii) Specify the number of Machine cycles, T-states, addressing mode and number of bytes for the instruction POP PSW and INR M of 8085.
   (b) Explain the key features of ARM Processor Architecture.

7. (a) Draw and explain Timing Diagram for the instruction LDAX B of 8085.
   (b) Specify and explain any five instructions of ARM processor.
(REVISED COURSE)

(3 Hours)  
[ Total Marks : 100 ]

N.B. (1) Question No. 1 is compulsory.
(2) Answer any four out of remaining six questions.
(3) Assume any suitable data wherever required but justify the same.
(4) Figures to the right indicate marks.

1. (a) The leads of a resistor in an RF circuit are treated as straight aluminium wires ($\sigma \, Al = 4.0 \times 10^7 \text{s/m}$) of AWG size 14 (cd = 64 mil) and of total length of 5 cm.
   
   (i) Compute the DC resistance
   (ii) Find the AC resistance and inductance at 100 MHz, 1 GHz, and 10 GHz operating frequencies.

(b) A load impedance of $40 + j \, 70$ ohms terminates a 100 ohms transmission line i.e. $0.3 \, \lambda$ long. Find the reflection coefficient of the load, the reflection coefficient at the input to the line, the input impedance, the SWR in the line and the return loss.

(c) For the filter configuration shown in the figure below, the following parameters are given:
   $Z_0 = 50$ ohms, $Z_G = Z_L = Z_0$, $R = 10$ ohm, $L = 50$ nH, $C = 0.47$ pF, and the generator voltage is $V_G = 5$ V. Find the external, Internal and loaded quality factor.

![Filter Configuration Diagram]

(d) Explain the design procedure of small signal BJT amplifier. (DC circuit design and RF circuit design).

2. (a) A particular RF circuit requires that a line impedance of 50 ohms is to be maintained. A selected PCB board with dielectric constant of 4.6 and thickness of 40 mil. Find phase velocity and wavelength at 2 GHz.

(b) Consider the case of matching a 73 ohm load to a 50 ohm line by means of a 1/4 transformer. Assume the matching is achieved for a center frequency of $f_c = 2$ GHz. Plot the SWR for the frequency range $1/3 \leq f/f_c \leq 3$.

3. (a) Design a prototype low-pass Butterworth filter that will provide at least 20 dB attenuation at the frequency of $f = 2 \, f_{3dB}$. Compute and plot the amplitude response for 0 to 5 GHz.

(b) Plot the insertion loss of a low pass Chebyshev filter that has 6 dB ripple in the passband and at least 50 dB attenuation at $f = 2 \, f_{cut-off}$.
4. (a) A two-port transistorized Network have the following scattering matrix:

\[
[s] = \begin{bmatrix}
0.15 & 0 & 0.85 & 0 \\
0.85 & 0 & 45^\circ & 0 \\
45^\circ & 0 & 0.2 & 0 \\
0 & 0 & 0 & 0.85 \\
\end{bmatrix}
\]

Determine whether the transistorized Network is Reciprocal and lossless. If port 2 is terminated with a matched load, what is the return loss seen at port 1? If port 2 is terminated with a short circuit, what is the return loss seen at port 1?

(b) A BJT is encapsulated in a plastic housing and mounted on a heat sink \( (R_{\text{thha}} = 3.75 \, ^\circ \text{C/w}) \) under these conditions the total power dissipation is supposed to be 20 W at an ambient temperature of 20 °C. What rating has the engineer to choose for the BJT casing if the maximum junction temperature should not exceed 175 °C.

5. (a) For small signal BJT amplifier shown, find the value of inductor that would provide negative feedback above \( f = 600 \, \text{MHz} \). Assume that the phase of \( S_{21} \) approaches 90° around 600 MHz.

(b) An abrupt pn-junction made of Si has the acceptor and donor concentrations of \( N_A = 10^{18} \, \text{cm}^{-3} \) and \( N_D = 5 \times 10^{15} \, \text{cm}^{-3} \), respectively. Assuming that the device operates at room temperature, determine:

(i) The barrier voltage
(ii) The space charge width in the p and n type semiconductors.
(iii) The peak electric field across the junction.
(iv) The junction capacitance for a cross sectional area of \( 10^{-4} \, \text{cm}^2 \) and a relative dielectric constant of \( \epsilon_r = 11.7 \).

6. (a) For the simplified FET model shown determine the capacitances \( C_{gs} \) and \( C_{gd} \) as well as \( g_m \). Show that for low frequency operation it is sufficient to record the drain current and gate-source voltage under short circuit output condition.

(b) Plot and compare the frequency response of BJT, FET and HEMT.

7. Write short notes on following:

(a) Chip components
(b) Matching Networks
(c) Parallel and series connections
(d) Coupled Filters.
N.B. (1) Question No. 1 is compulsory.
(2) Answer any four out of remaining six questions.
(3) Assume any suitable data wherever required but justify the same.
(4) Figures to the right indicate marks.

1. (a) The leads of a resistor in an RF circuit are treated as straight aluminium wires ($\sigma_{Al} = 4.0 \times 10^7 \text{s/m}$) of AWG size 14 cd = 64 mil) and of total length of 5 cm.
   (i) Compute the DC resistance
   (ii) Find the AC resistance and inductance at 100 MHz, 1 GHz, and 10 GHz operating frequencies.

(b) A load impedance of $40 + j 70$ ohms terminates a 100 ohms transmission line i.e. $0.3\lambda$ long. Find the reflection coefficient of the load, the reflection coefficient at the input to the line, the input impedance, the SWR in the line and the return loss.

(c) For the filter configuration shown in the figure below, the following parameters are given:
   $Z_0 = 50$ ohms, $Z_G = Z_L = Z_0$, $R = 10$ ohm, $L = 50$ nH, $C = 0.47$ pF, and the generator voltage is $V_G = 5$ V. Find the external, internal and loaded quality factor.

(d) Explain the design procedure of small signal BJT amplifier. (DC circuit design and RF circuit design).

2. (a) A particular RF circuit requires that a line impedance of 50 ohms is to be maintained. A selected PCB board with dielectric constant of 4.6 and thickness of 40 mil. Find phase velocity and wavelength at 2 GHz.

(b) Consider the case of matching a 73 $\Omega$ load to a 50 ohm line by means of a $\lambda/4$ transformer. Assume the matching is achieved for a center frequency of $f_c = 2$ GHz. Plot the SWR for the frequency range $1/3 \leq f/f_c \leq 3$.

3. (a) Design a prototype low-pass Butterworth filter that will provide at least 20 dB attenuation at the frequency of $f = 2 f_{3dB}$. Compute and plot the amplitude response for 0 to 5 GHz.

(b) Plot the insertion loss of a low pass Chebyshev filter that has 6 dB ripple in the passband and at least 50 dB attenuation at $f = 2 f$ cut-off.
4. (a) A two-port transistorized Network have the following scattering matrix:

\[
[s] = \begin{bmatrix}
0.15 & 0.85 \\
0.85 & 0.2
\end{bmatrix}
\]

Determine whether the transistorized Network is Reciprocal and lossless. If port 2 is terminated with a matched load, what is the return loss seen at port 1? If port 2 is terminated with a short circuit, what is the return loss seen at port 1?

(b) A BJT is encapsulated in a plastic housing and mounted on a heat sink \((R_{\text{thh}} = 3.75 \, ^\circ \text{C/W})\) under these conditions the total power dissipation is supposed to be 20 W at an ambient temperature of 20 °C. What rating has the engineer to choose for the BJT casing if the maximum junction temperature should not exceed 175 °C.

5. (a) For small signal BJT amplifier shown, find the value of inductor that would provide negative feedback above \(f = 600 \, \text{MHz}\). Assume that the phase of \(S_{21}\) approaches 90° around 600 MHz.

(b) An abrupt pn-junction made of \(S_j\) has the acceptor and donor concentrations of \(N_A = 10^{18} \, \text{cm}^{-3}\) and \(N_D = 5 \times 10^{15} \, \text{cm}^{-3}\), respectively. Assuming that the device operates at room temperature, determine:

(i) The barrier voltage
(ii) The space charge width in the p and n type semiconductors.
(iii) The peak electric field across the junction.
(iv) The junction capacitance for a cross sectional area of \(10^{-4} \, \text{cm}^2\) and a relative dielectric constant of \(\varepsilon_r = 11.7\).

6. (a) For the simplified FET model shown determine the capacitances \(C_{gs}\) and \(C_{gd}\) as well as \(g_m\). Show that for low frequency operation it is sufficient to record the drain current and gate-source voltage under short circuit output condition.

(b) Plot and compare the frequency response of BJT, FET and HEMT.

7. Write short notes on following:
   (a) Chip components
   (b) Matching Networks
   (c) Parallel and series connections
   (d) Coupled Filters.
N.B. (1) Question No. 1 is **compulsory**.
(2) Answer any four out of remaining six questions.
(3) **Figures** to the right indicate full marks.
(4) Illustrate answers with **sketches** wherever required.

1. (a) Define sensitivity. How can we reduce the sensitivity of closed loop system? 20
(b) State the properties of Transfer function.
(c) Explain Hurwitz Stability Criterion. What are the Disadvantages?
(d) What are the advantages of Bode Plot?

2. (a) Determine the value of $V_o(t)$ if —
\[
C_2 = 5C_1, \\
V_i(t) = 40e^{-20t}, \\
C_1 = 0.5 \text{ uf}, \\
R = 100 \text{ m}\Omega.
\]

(b) Explain the effect of an additional zero and additional pole to the standard second order system.

3. (a) Consider the following block diagram shown in **figure** below. Draw its equivalent signal flow graph and find $C(s)/R(s)$ using Mason's gain formula.

(b) Derive the transfer function of armature controlled dc servomotor and obtain the resulting block diagram.
4. (a) Using block diagram reduction rule, obtain the transfer function of the system shown in figure below:

(b) The open loop transfer function of a feedback system is:

\[ G(s)H(s) = \frac{K}{s(s + 4)(s^2 + 4s + 20)} \]


5. (a) Determine the value of K for unity feedback control system having:

\[ G(s)H(s) = \frac{K}{s(s + 2)(s + 4)} \]

(i) Phase margin = 60°
(ii) Gain margin = 20 dB

(b) Derive and analyse the response of a second order system to a unit step. With the help of graphical plots explain the significance of damping ratio for its various values.

6. (a) The output of a control system is related to its input by:

\[ (s^4 + 2s^3 + 2s^2 + (3 - K)s + K) C(s) = K(s + 1) R(s) \]

Where K represents the positive gain of an amplifier.

(i) With K = 6 and a step input will the output response be stable?
(ii) Determine the limiting value that K can have for a stable output response.

(b) Obtain the Transfer function of field controlled D.C. Motor. Draw block diagram.

7. Write short notes on any two of the following:

(a) A. C. Servomotors
(b) Tachogenerators
(c) Error compensation methods and their effects on system performance.
N.B. (1) Question No. 1 is compulsory.
(2) Attempt any four questions from the remaining questions.
(3) Assume any suitable data if necessary.

1. (a) Give following definitions of probability with the shortcomings if any—
   (i) A-priori or Classical definition.
   (ii) A-posteriori or relative frequency definition.
   (iii) Axiomatic definition.

   (b) State and prove Bay's theorem.

   (c) Define Markov chain giving an example.

   (d) State and explain joint and conditional probabilities of events.

2. (a) X and Y are two continuous random variables, then joint probability density function is given by—

   \[ f_{xy} = \begin{cases} 
   ce^{-x}e^{-y}, & 0 \leq y < x \leq \infty \\
   0, & \text{elsewhere} 
   \end{cases} \]

   (i) Find the value of normalization constant c.

   (ii) \( f_x(x) \)

   (iii) \( F_y(y) \)

   (iv) \( F_x(x/y) \)

   (v) \( F_y(y/x) \)

   (vi) \( E(y/x) \)

   (vii) \( E(x/y) \)

   (b) A mechanism consist of three paths A, B, C and probabilities of their failure are p, q, r respectively. The mechanism work if there is no failure in any of these parts. Find the probability that—

   (i) Mechanism is working

   (ii) Mechanism is not working.

3. (a) If \( f_{xy} (x,y) = \begin{cases} 
   2e^{-x}e^{-y}, & 0 \leq y \leq x < \infty \\
   0, & \text{elsewhere} 
   \end{cases} \)

   Find correlation coefficient of X and Y. Are X and Y independent?

   (b) A continuous random variable has the probability density function

   \[ f_x(x) = 6(x - x^2), \quad 0 \leq x \leq 1 \]

   Find mean and variance.
Con. 3436-AN-4276-10.

4. (a) State and prove properties of autocorrelation function and cross correlation function.
(b) The power spectrum of WSS process $x(t)$ is given by
\[ S(w) = \frac{1}{(1 + \omega^2)^2} \]
Find its autocorrelation function $R(\tau)$ and average power.

5. (a) A random process is defined by $X(t) = A \cos(\omega_0 t + \theta)$ where $A$ and $\omega_0$ are constants and $\theta$ is random variable uniformly distributed over $(0, 2\pi)$. Show that process is ergodic in mean and also in correlation.
(b) Find the power spectral density function of random process whose autocorrelation function is
\[ R(\tau) = 1 - |\tau|/T, \quad |\tau| \leq T \\
= 0, \quad \text{elsewhere} \]

6. (a) (i) Define central limit theorem and give its significance.
(ii) Define strong law of large numbers.
(iii) Describe sequence of random variables.
(b) (i) If today is Wednesday and whether is in state 2 what is the probability that the weather is in state 3 on Thursday and the state 1 on Friday?
(ii) What is the probability whether on Friday is in state 1, given that it is in state 2 on Wednesday?

7. (a) Consider that the society is divided into three income groups, low, middle and high, suppose that the transition probability that the next generation will grow from one income group to the other or will be in the same group is as given below:
\[
\begin{bmatrix}
L & M & H \\
L & 0.45 & 0.48 & 0.07 \\
M & 0.05 & 0.7 & 0.25 \\
H & 0.01 & 0.5 & 0.49 \\
\end{bmatrix}
\]
Find the limiting probabilities.
(b) Find the characteristic function of the Laplace distribution.
\[ f(x) = (m/2) e^{-mx}, \quad -\infty < x < \infty. \]
Also find its mean and variance.
1. Answer any four of the following:—
   (a) Find the ROC of the given signal
   \[ x(t) = 3e^{-2t} u(t) - 2e^{-t} u(t). \]

   (b) Determine the direct form - I realisation for the following transfer function
   \[ H(z) = 1 - 0.7 z^{-1} + 0.4 z^{-2}. \]

   (c) A linear-time invariant (LTI) system is characterized by the following difference equation:
   \[ y(n) = a y(n - 1) + b x(n) \text{ for } 0 < a < 1 \]
   Find the magnitude and phase of the frequency response \( H(e^{j\omega}) \) of the system.

   (d) Determine the signal energy and signal power for the following signals:
   (i) \( x(t) = e^{-\frac{t}{2}} \)
   (ii) \( x(t) = e^{-\frac{t}{3}} \)

   (e) State and explain convolution property of Z-transform.

2. (a) Consider the analog signal \( x_a(t) = 5 \sin 200\pi t \)
   (i) Determine the minimum required sampling rate to avoid sampling.

   (ii) Suppose that the signal is sampled at the rate \( F_s = 100 \text{ Hz} \). What is the discrete time signal obtained after sampling?

   (iii) Suppose that the signal is sampled at the rate \( F_s = 300 \text{ Hz} \), what is the discrete time signal obtained after sampling?

   (b) Impulse response of a discrete-time LTI system is expressed as under:
   \[ h(n) = \{1, 2, 3\} \]
   Find the i/p sequence \( x(n) \) for output response which is given by —
   \[ y(n) = \{1, 1, 2, -1, 3\} \]
3. (a) Compute the response of the system \( y(n) = 0.7 y(n-1) - 0.12 y(n-2) + x(n-1) + x(n-2) \) to input \( x(n) = nu(n) \). Is the system stable?

(b) Obtain the Fourier transform of a rectangular pulse of duration 2 seconds and having a magnitude of 10 volts.

4. (a) Find the Fourier series for the function \( x(t) \) defined by

\[
x(t) = \begin{cases} 
0 & -\frac{T}{2} < t < 0 \\
A \sin w_0 t & 0 < t < \frac{T}{2}
\end{cases}
\]

and \( x(t + T) = x(t) \), \( w_0 = \frac{2\pi}{T} \).
1. (a) With the help of a neat diagram explain the important features of butting and buried contact. 5
   (b) What buried layer? What is its importance in BJT technology. 5
   (c) What are the different ways to adjust threshold voltage of MOSFET. 5
   (d) What are the advantages of twin-tube process over n-well process. 5

2. (a) Explain with neat diagram fabrication of CMOS Inverter using n-well technology. 10
   (b) Discuss parasitic effects in MOSFET. 10

3. (a) What are the different types of MOSFET scaling? Explain each in detail with their advantages and disadvantages. 10
   (b) What are short channel effects? Explain in detail. 10

4. (a) Draw the layout of 2 input CMOS NAND gate using $\lambda$ (lambda) rules. 10
   (b) Draw transfer characteristics of CMOS Inverter and explain it in detail. 10

5. (a) Calculate the threshold voltage $V_{TO}$ at $V_{SB} = 0$, for a polysilicon gate n-channel MOSFET with the following parameters:
   (i) Substrate doping density $N_A = 10^{16}$ cm$^{-3}$
   (ii) Polysilicon gate density $N_D = 2 \times 10^{20}$ cm$^{-3}$
   (iii) Gate oxide thickness $t_{ox} = 500$ Å
   (iv) Oxide-interface charge density $N_{ox} = 4 \times 10^{10}$ cm$^{-2}$.

   Data: 
   \[
   \begin{align*}
   \frac{KT}{q} &= 26 \text{ mV}, \quad n_i = 1.45 \times 10^{10} \text{ cm}^{-3}, \quad q = 1.6 \times 10^{-19} \text{ Coul}, \\
   \varepsilon_o &= 8.85 \times 10^{-14} \text{ F/cm}, \quad \varepsilon_{si} = 11.7 \times \varepsilon_o \text{ F/cm}, \\
   \varepsilon_{ox} &= 3.97 \times \varepsilon_o \text{ F/cm}.
   \end{align*}
   \]

   (b) Explain in detail ion implantation technique. 10
6. (a) What are different techniques used to grow single crystal silicon? Explain any one in detail.

(b) Implement following function using standard CMOS. Also draw stick diagram.

\[
\begin{align*}
(i) \quad Z &= (A + B) (C + D) + AD \\
(ii) \quad Z &= \overline{A \overline{B}} + AB
\end{align*}
\]

7. Write short notes on any four:

(a) Photolithography
(b) CMOS Latchup
(c) \(\lambda\)-based Layout Rules
(d) TTL NAND Gate
(e) IC Cross Overs.

********
1. Write short notes (any two):—
   (a) Difference between active and passive differs
   (b) Switched capacitor Akerberg Mossberg filter
   (c) Properties of a Butterworth function.

2. (a) Derive the Transfer function of Sallen and Key low-pass filter.
    (b) Synthesize a passive network to realize the transfer function given below with 1Ω termination resistor:

\[ Y_T(s) = \frac{s(s^2 + 9)}{2s^3 + s^2 + 8s + 1} \]

3. (a) Determine the Transfer function of the following circuit:

(b) Develop and implement a second order normalized low pass Butterworth filter transform it to a normalized Band reject filter.

4. (a) Sketch the gain versus frequency for the voltage transfer function given below:

\[ T(s) = \frac{s^2 + 16}{s^2 + 2s + 100} \]

(b) Draw the circuit configuration for Generalized Impedance Converter (GIC). Analyse it and determine transmission parameters.

5. (a) What is bi-quadratic function, identify the bi-quadratic parameters K, \( W_2, W_p, Q_2, Q_p \) from the following function \( H(s) = \frac{4s^2 + 16}{2s^2 + 6s + 12} \).

(b) Synthesize the following function:

\[ Z(s) = \frac{s^3 + 2s}{s^2 + 1} \]
6. (a) Explain how resistor is realized by a MOS switched capacitor.  
(b) Synthesize the following function –

\[ Z(s) = \frac{s(s^2 + 2)}{(s^2 + 1)(s^2 + 3)} \]

7. (a) Find the denormalized network for the given network circuit and Transfer function

\[ N_n(p) = \frac{0.6p}{p^2 + 0.6p + 2} \] and cut-off frequency \( f_c = 10 \text{ KHz} \).

(b) Draw the neat circuit diagram of Tow-Thomas filter and derive the transfer function for low pass and band pass filter realizations.
N.B. (1) Question No. 1 is compulsory.
(2) Attempt any four out of remaining six.
(3) Assume suitable data wherever necessary.

1. Design 8086 based microprocessor system with following specifications –
   (a) CPU working at 8 MHz
   (b) Numeric data processor, 8087
   (c) 32 kB SRAM using 8 kB devices
   (d) 64 kB EPROM using 16 kB devices
   (e) Two, 8 bit input parts
   (f) Two, 8 bit output parts.
   Show memory map and I/o map with decoding logic. Use absolute decoding.

2. (a) Write an assembly language program for 8085 to find positive, negative numbers
      in an array of 50 elements.
   (b) Write an assembly language program using 8086 instructions to display a string
       'MICROPROCESSOR'.

3. (a) Explain serial communication with 8085 microprocessor. Also mention the instructions
      used for the same.
   (b) Draw and explain timing diagram for STA 2050 h.

4. (a) Explain ICWs and OCWs at 8259 PIC.
      (b) Draw the functional block diagram of 8255 and explain its modes at operation.

5. (a) Explain the interrupts of 8086 microprocessor.
      (b) Explain all the addressing modes of 8086 with examples.

6. (a) What do you mean by mixed language programming? Explain with an example
      containing IF-THEN-ELSE statement.
   (b) Explain the role of 8288 bus controller in maximum made of 8086.

7. Write short notes :-
   (a) Modes of DMA transfer
   (b) Assembler directives
   (c) 8254 PIT.
Con. 3642-10.

(OLD COURSE)

Computer Architecture & Organisation

(3 Hours)

[Total Marks: 100]

N.B. : (1) Question No. 1 is compulsory.
(2) Attempt any four questions out of remaining six questions.

1. (a) Distinguish Hardwired and Microprogrammed control unit. 7
(b) Explain steps involved in design of ALU. 7
(c) Differentiate between RISC and CISC characteristics. 6

2. (a) Explain the control unit design for gcd processors using state table method. 10
(b) Explain the different mapping techniques used in the design of Cache memory. 10

3. (a) Write a short note on MIMD. 10
(b) Explain the use of Guard bits and Rounding methods for floating point numbers. 10

4. (a) Explain any two hardwired control unit design techniques. 10
(b) Explain any two techniques of bus arbitration. 10

5. (a) Distinguish interrupt driven I/O and programmed I/O. 10
(b) Explain Booth's algorithm for multiplication of signed numbers. 10

6. (a) What do you mean by addressing mode? Explain addressing modes. 10
(b) Write the necessity of page replacement algorithm? List and explain different page replacement algorithms. 10

7. (a) Compare SRAM and DRAM. 8
(b) What are advantages of pipelining? Explain with respect to a floating point data path. Prove that for a K stage pipeline, the speed up factor = K. 12

*******
Con. 3642-10. 
(OLD COURSE) 

Sub: C.A 

(3 Hours) 
[Total Marks: 100]

N.B.: (1) Question No. 1 is compulsory.
   (2) Attempt any four questions out of remaining six questions.

1. (a) Distinguish Hardwired and Microprogrammed control unit. 7
   (b) Explain stops involved in design of ALU. 7
   (c) Differentiate between RISC and CISC characteristics. 6

2. (a) Explain the control unit design for gcd processors using state table method. 10
   (b) Explain the different mapping techniques used in the design of Cache memory. 10

3. (a) Write a short note on MIMD. 10
   (b) Explain the use of Guard bits and Rounding methods for floating point numbers. 10

4. (a) Explain any two hardwired control unit design techniques. 10
   (b) Explain any two techniques of bus arbitration. 10

5. (a) Distinguish interrupt driven I/O and programmed I/O. 10
   (b) Explain Booth’s algorithm for multiplication of signed numbers. 10

6. (a) What do you mean by addressing mode? Explain addressing modes. 10
   (b) Write the necessity of page replacement algorithm? List and explain different page replacement algorithms. 10

7. (a) Compare SRAM and DRAM. 8
   (b) What are advantages of pipelining? Explain with respect to a floating point data path. Prove that for a K stage pipeline, the speed up factor = K. 12

*********
Con. 3793-10.

(OLD COURSE) AN-4060
(3 Hours) [Total Marks: 100]

N.B. (1) Question No. 1 is compulsory.
(2) Attempt any four questions out of remaining six questions.
(3) Draw suitable diagrams wherever needed.
(4) Make suitable assumption wherever needed and mention the same.

1. Answer the following questions any four:
   (a) Describe LM 380 as phono-amplifier
   (b) With neat sketch explain first order digital phase locked loop
   (c) Explain about capture range and lock range in PLL. Which one is greater? Why?
   (d) Discuss input compensation technique for broadbanding
   (e) What is meant by hybrid transformer?

2. (a) Design a Direct Digital Frequency Synthesizer to generate $15.8 \times 10^6$ Hz from a $1 \times 10^6$ Hz reference oscillator.
   (b) Discuss in detail the analysis of a series RLC circuit with pole-zero diagram.

3. (a) Derive the equation for noise factor of a cascaded five networks.
   (b) What minimum input signal will give output signal to noise ratio of 0 db in a system with input impedance of 50 Ω, a noise figure of 8 db and a bandwidth of 2.1 KHz? Take operating temperature as 290 K.

4. (a) Derive transfer function of second order PLL and explain magnitude plot as function of frequency for this PLL.
   (b) Explain frequency synthesizer that uses variable modulus divider.
   (c) Explain how switching time can be reduced in frequency synthesizer.

5. (a) Explain how impedance level shifting can be accomplished in narrow band circuits without incurring cost of expensive and bulky transformer. Include proper mathematics for justification.
   (b) Explain different methods of neutralization and feedback technique used in wideband amplifiers.

6. (a) Design a loss less coupling network that match a load of $(12 + j5) \, \Omega$ to a 40 Ω source impedance of 20 MHz.
   (b) Explain use of PLL as:
      (i) Tracking filter
      (ii) Signal synchronizer.

7. Write short notes any two:
   (a) Switching type mixer
   (b) AM modulator using 1596
   (c) Parallel RLC circuit giving an application
   (d) Hybrid transformer.